

3A, 50V - 1000V Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- · High current capability
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

_		_	IC	-	_			^
^			-	^			ы,	-
_	_	_		_		•	ч.	-

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

KEY PARAMETERS							
PARAMETER	VALUE	UNIT					
I _{F(AV)}	3	Α					
V_{RRM}	50 - 1000	V					
I _{FSM}	100	Α					
T _{J MAX}	150	°C					
Package	DO-214AB (SMC)						
Configuration	Single die						

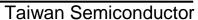




DO-214AB (SMC)

PARAMETER	SYMBOL	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT
Marking code on the device		S3A	S3B	S3D	S3G	S3J	S3K	S3M	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Forward current	I _{F(AV)}	3					Α		
Surge peak forward current, 8.3 ms single half sine-wave uperimposed on rated load per diode	I _{FSM}	100					А		
Junction temperature	TJ	- 55 to +150						°C	
Storage temperature	T _{STG}	- 55 to +150						°C	

1





THERMAL PERFORMANCE								
PARAMETER	SYMBOL	TYP	UNIT					
Junction-to-lead thermal resistance per diode	R _{OJL}	13	°C/W					
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	47	°C/W					

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS SYMBO		TYP.	MAX.	UNIT		
Forward voltage per diode (1)	I _F = 3A, T _J = 25°C	V _F	-	1.15	V		
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C		-	10	μA		
Reverse current @ rated v _R per diode	T _J = 125°C	- I _R	-	250	μA		
Junction capacitance	1 MHz, V _R =4.0V	CJ	60	-	pF		
Reverse recovery time	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	1500	-	ns		

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION								
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING			
	н	R7	G	SMC	850 / 7" Plastic reel			
		R6		SMC	3,000 / 13" Paper reel			
S3x (Note 1,2)		M6		SMC	3,000 / 13" Plastic reel			
(Note 1,2)		V7		Matrix SMC	850 / 7" Plastic reel			
		V6		Matrix SMC	3,000 / 13" Plastic reel			

Note:

- 1. "x" defines voltage from 50V (S3A) to 1000V (S3M)
- 2. Only V6 and V7 are all green compound (halogen free)

EXAMPLE								
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION			
S3AHR7G	S3A	Н	R7	G	AEC-Q101 qualified Green compound			



3.5

0

25

50

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

AVERAGE FORWARD CURRENT (A) 3 2.5 2 1.5 1 0.5 RESISTIVE OR INDUCTIVE LOAD

Fig.2 Typical Junction Capacitance

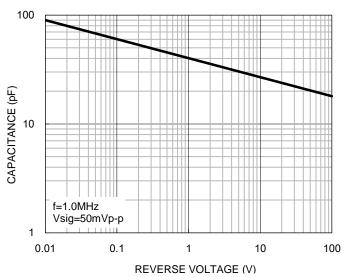


Fig.3 Typical Reverse Characteristics

75

LEAD TEMPERATURE (°C)

100

125

150

3

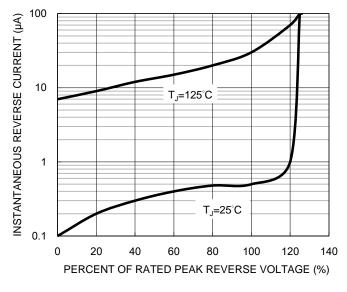
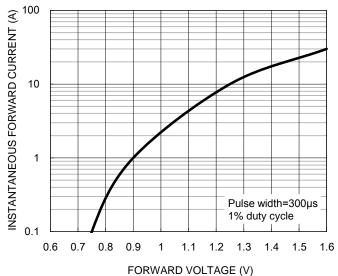


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

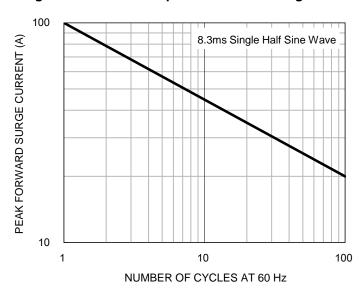
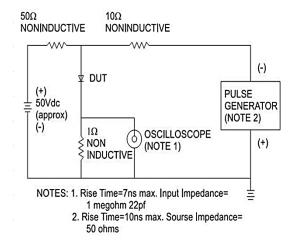
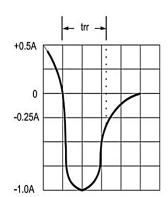


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram



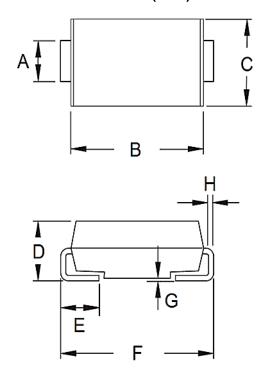


4



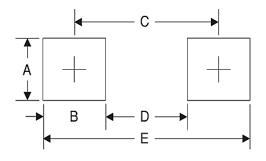
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
E	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM

Matrix SMC





SMC

P/N =Marking Code

G =Green Compound

YW =Date Code F =Factory Code

5 Version:M1903



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.